OSRAM LYG T67K

Datasheet

Published by ams-OSRAM AG
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OSRAM

Multi TOPLED®

LYG T67K

Two chip LEDs for indicators that allow to display yellow and green



Applications

- Access Control & Security
- Appliances & Tools
- Factory Automation
- Home & Building Automation
- Projection & Display
- Robotics
- Static Signaling

Features

- Package: white PLCC-4 package, colorless clear resin
- Chip technology: Volume emitter (InGaAlP)
- Typ. Radiation: 120° (Lambertian emitter)
- Color: λ_{dom} = 587 nm (● yellow); λ_{dom} = 570 nm (● green)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

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Ordering Information

Type	Brightness [1]	Ordering Code
LYG T67K-JL-1+HK-1		Q65111A8859
yellow	I_v = 4.5 ... 18.0 mcd (I_F = 2 mA)	
green	I_v = 2.8 ... 11.2 mcd (I_F = 2 mA)	

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Maximum Ratings

Parameter	Symbol		Values ● yellow	Values ● green
Operating Temperature	T_{op}	min. max.	-40 °C 100 °C	-40 °C 100 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 100 °C	-40 °C 100 °C
Junction Temperature	T_j	max.	125 °C	125 °C
Forward Current T_S = 25 °C	I_F	max.	15 mA	15 mA
Forward Current pulsed t ≤ 10 µs; D = 0.005 ; T_S = 25 °C	$I_{F\ pulse}$		100 mA	100 mA
Reverse voltage [2)] T_S = 25 °C	V_R	max.	12 V	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV	2 kV

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Characteristics

I_F = 2 mA; T_S = 25 °C

Parameter	Symbol		Values ● yellow	Values ● green
Peak Wavelength	λ_{peak}	typ.	591 nm	572 nm
Dominant Wavelength [3]	λ_{dom}	min. typ. max.	580 nm 587 nm 595 nm	566 nm 570 nm 575 nm
Spectral bandwidth at 50% $I_{rel,max}$	$\Delta\lambda$	typ.	17 nm	16 nm
Viewing angle at 50% I_V	2φ	typ.	120 °	120 °
Forward Voltage [4] I_F = 2 mA	V_F	min. typ. max.	1.70 V 1.90 V 2.20 V	1.70 V 1.90 V 2.20 V
Reverse current [2] V_R = 12 V	I_R	typ. max.	0.01 µA 10 µA	0.01 µA 10 µA
Temperature Coefficient of Peak Wavelength	$TC_{\lambda peak}$	typ.	0.12 nm / K	0.1 nm / K
Real thermal resistance junction/ambient [5][6] IF = f (T) 1 Chip on	$R_{thJA\ real}$	max.	480 K / W	480 K / W
Real thermal resistance junction/solderpoint [5] IF = f (T) 1 Chip on	$R_{thJS\ real}$	max.	260 K / W	260 K / W

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Brightness Groups

Color of emission	Group	Luminous Intensity [1] I_F = 2 mA min. I_v	Luminous Intensity [1] I_F = 2 mA max. I_v	Luminous Flux [7] I_F = 2 mA typ. Φ_V
yellow	J	4.5 mcd	7.1 mcd	17.4 mlm
yellow	K	7.1 mcd	11.2 mcd	27.4 mlm
yellow	L	11.2 mcd	18.0 mcd	43.8 mlm
green	H	2.8 mcd	4.5 mcd	11.0 mlm
green	J	4.5 mcd	7.1 mcd	17.4 mlm
green	K	7.1 mcd	11.2 mcd	27.4 mlm

Group Name on Label

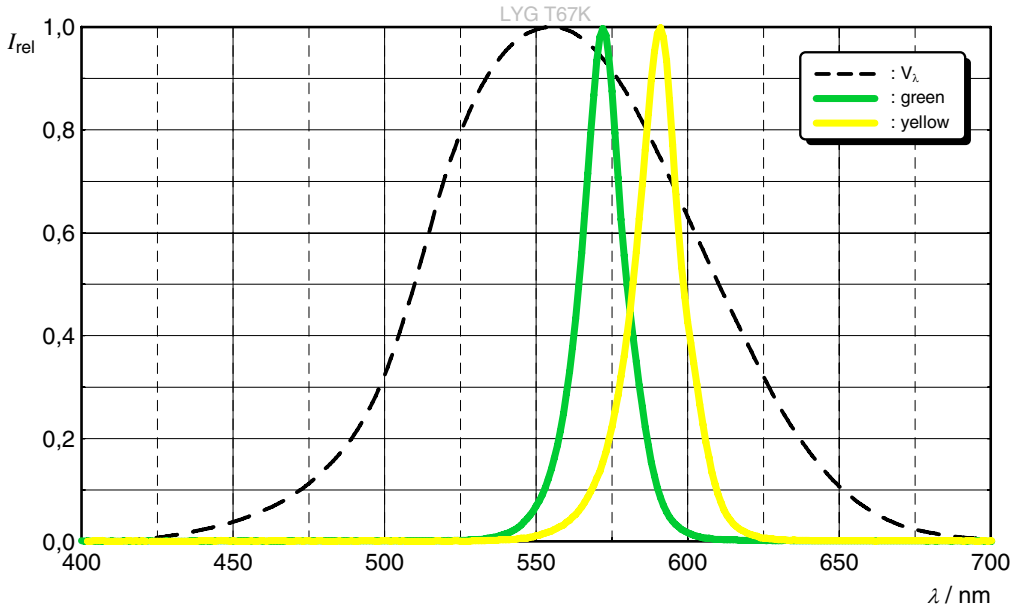
Example: J-1+H-1

Color	Brightness	Wavelength
yellow	J	1
green	H	1

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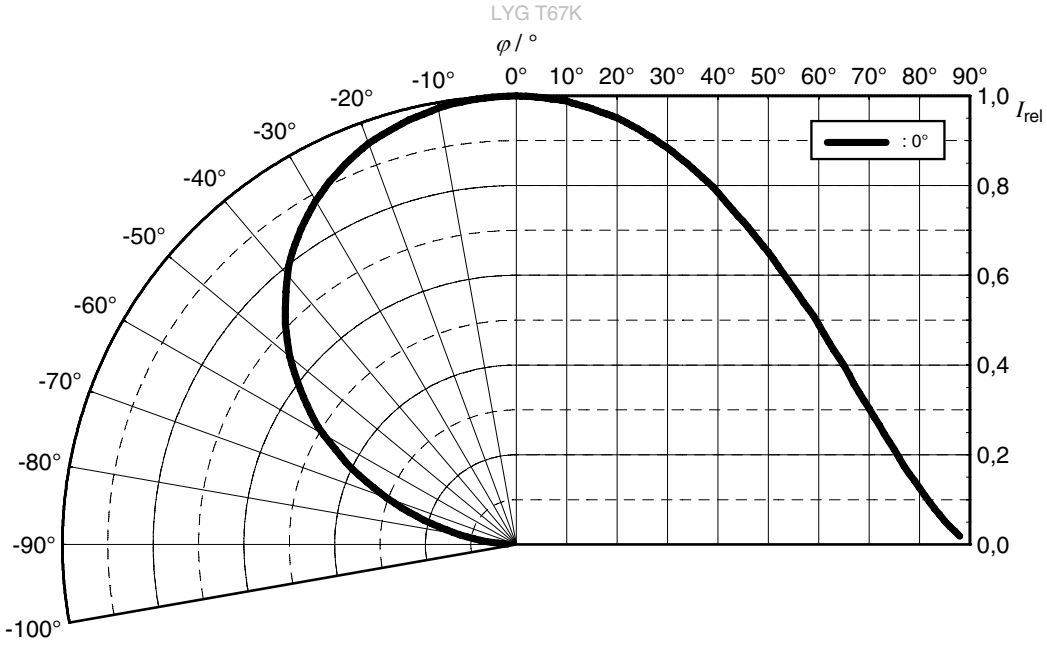
Relative Spectral Emission [7)]

$I_{rel} = f(\lambda)$; I_F = 2 mA; T_S = 25 °C



Radiation Characteristics [7)]

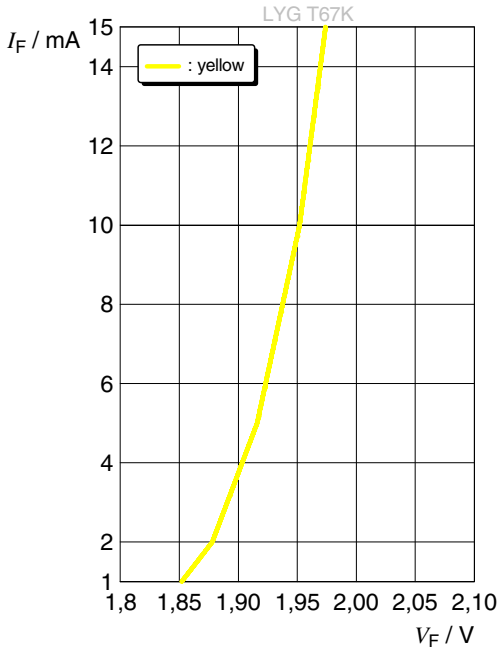
$I_{rel} = f(\varphi)$; T_S = 25 °C



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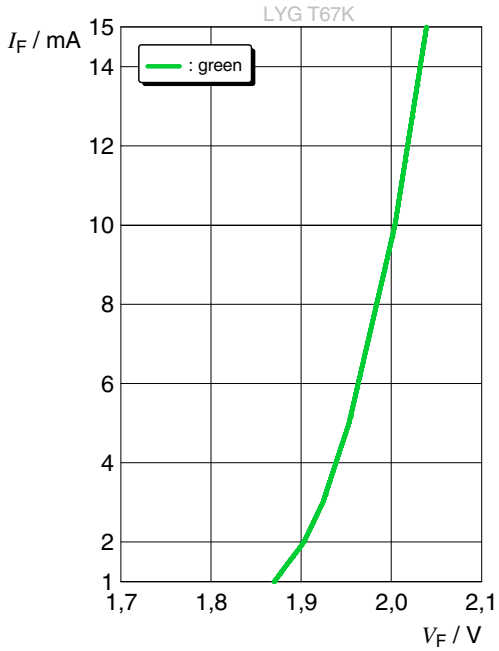
Forward current [7]

$I_F = f(V_F)$; T_S = 25 °C



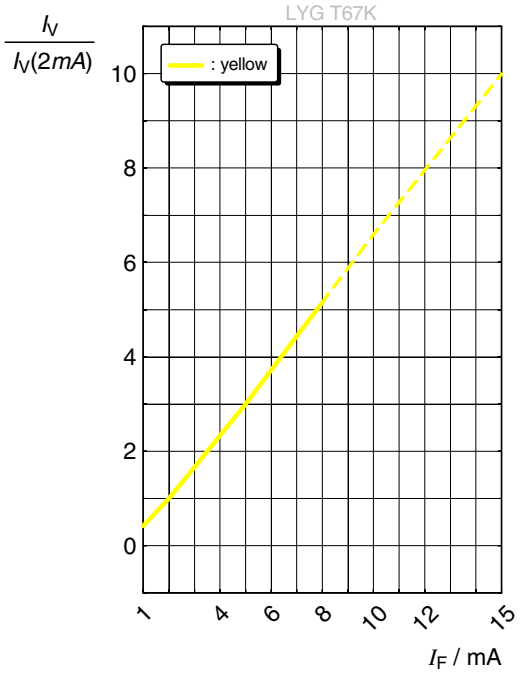
Forward current [7]

$I_F = f(V_F)$; T_S = 25 °C



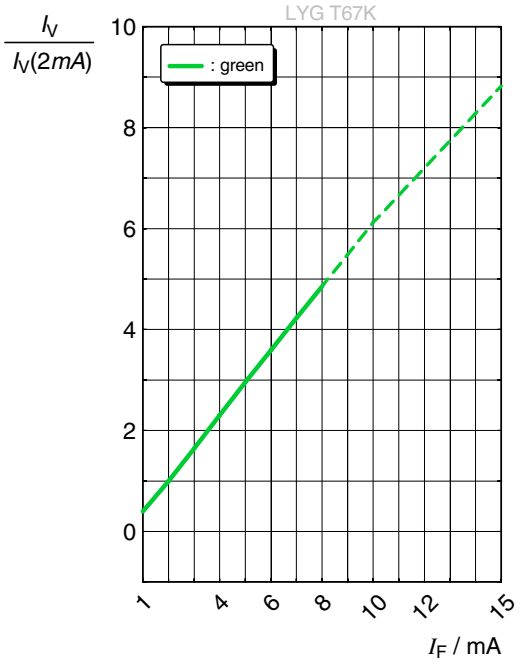
Relative Luminous Intensity [7], [8]

$I_v/I_v(2\ mA) = f(I_F)$; T_S = 25 °C



Relative Luminous Intensity [7], [8]

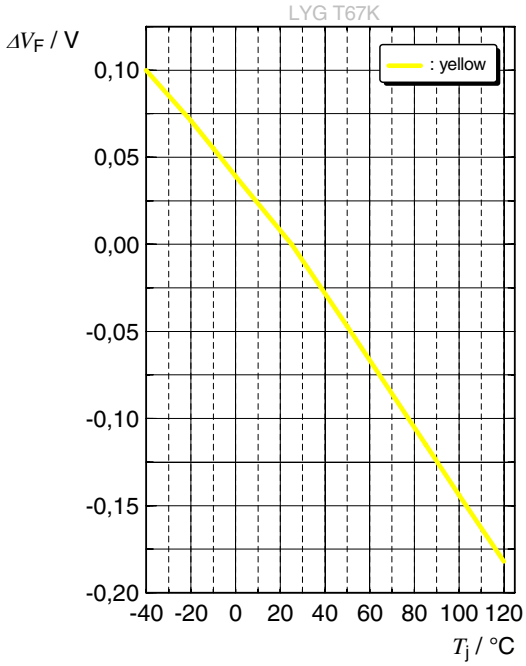
$I_v/I_v(2\ mA) = f(I_F)$; T_S = 25 °C



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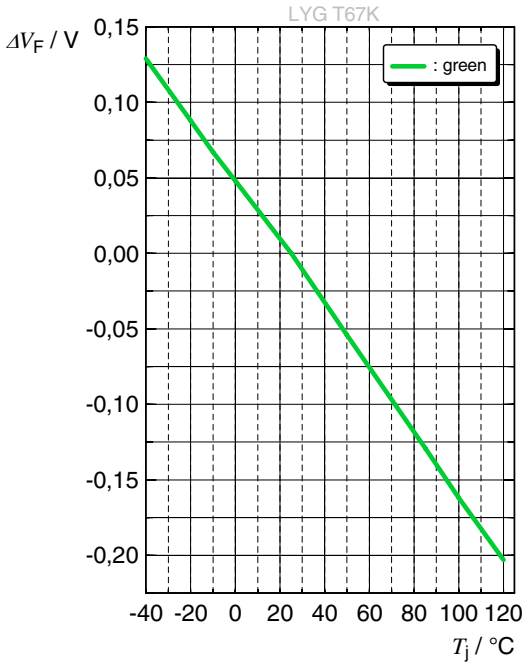
Forward Voltage [7)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 2\ mA$



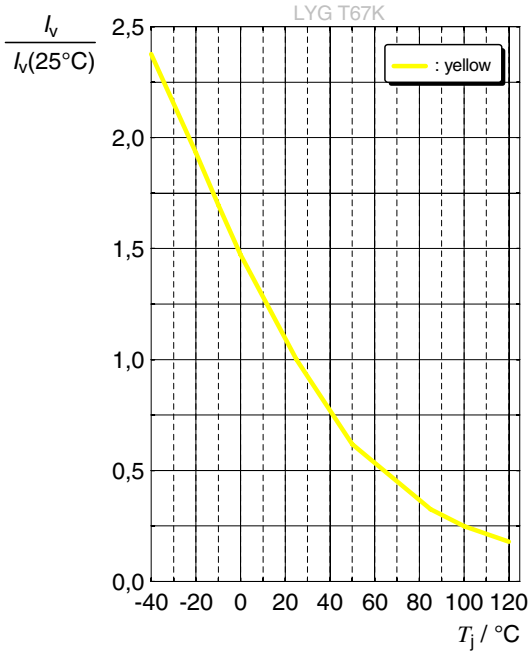
Forward Voltage [7)]

$\Delta V_F = V_F - V_F(25\ °C) = f(T_j);\ I_F = 2\ mA$



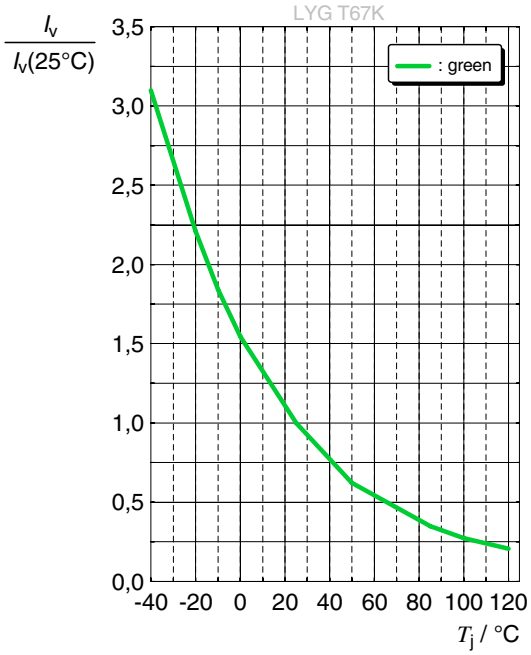
Relative Luminous Intensity [7)]

$I_v/I_v(25\ °C) = f(T_j);\ I_F = 2\ mA$



Relative Luminous Intensity [7)]

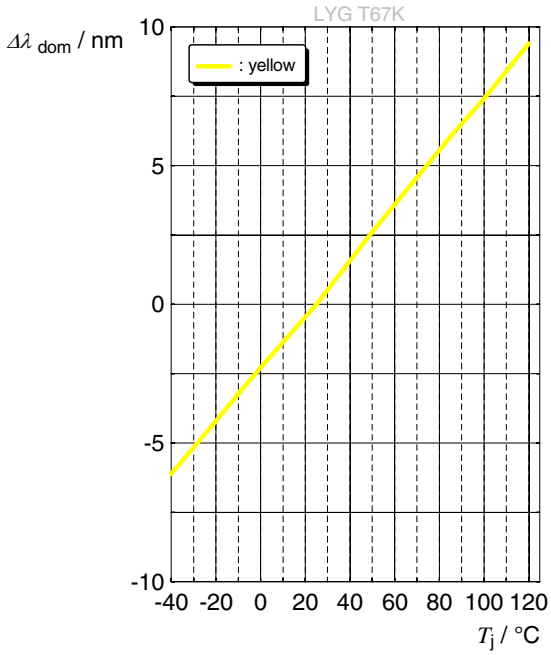
$I_v/I_v(25\ °C) = f(T_j);\ I_F = 2\ mA$



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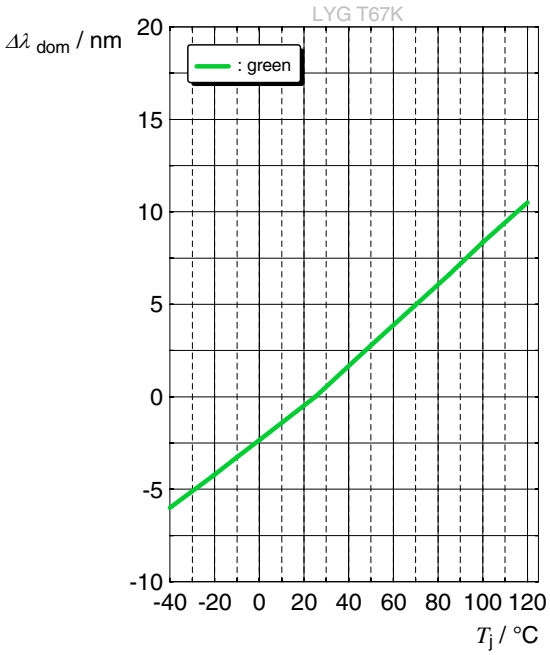
Dominant Wavelength [7)]

$\lambda_{dom} = f(T_j)$; I_F = 2 mA



Dominant Wavelength [7)]

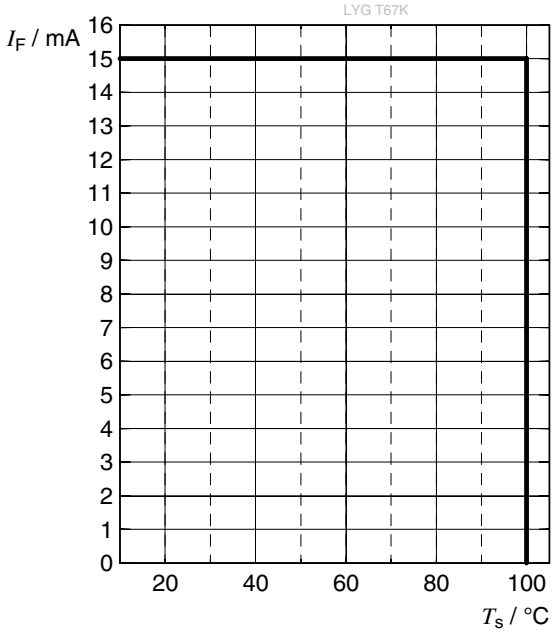
$\lambda_{dom} = f(T_j)$; I_F = 2 mA



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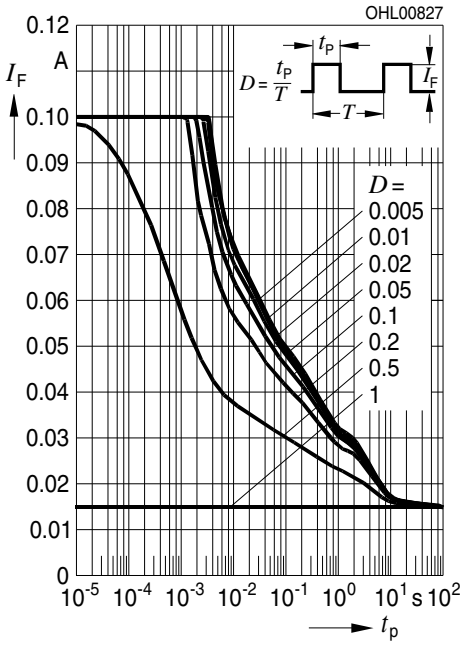
Max. Permissible Forward Current [5)]

IF = f (T)
1 Chip on



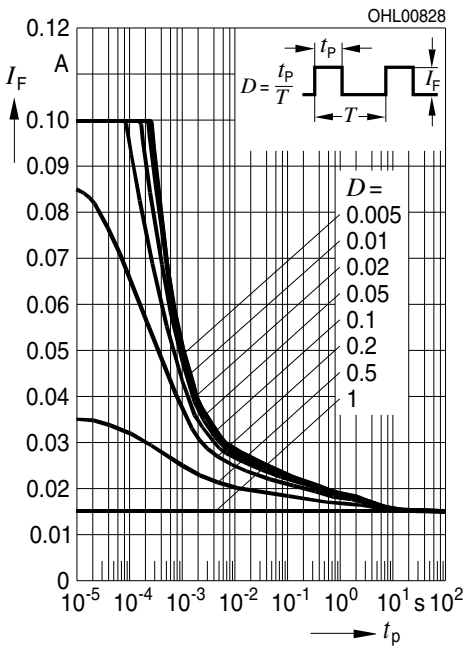
Permissible Pulse Handling Capability

IF = f(tp); D: Duty cycle; T_S = 25 °C



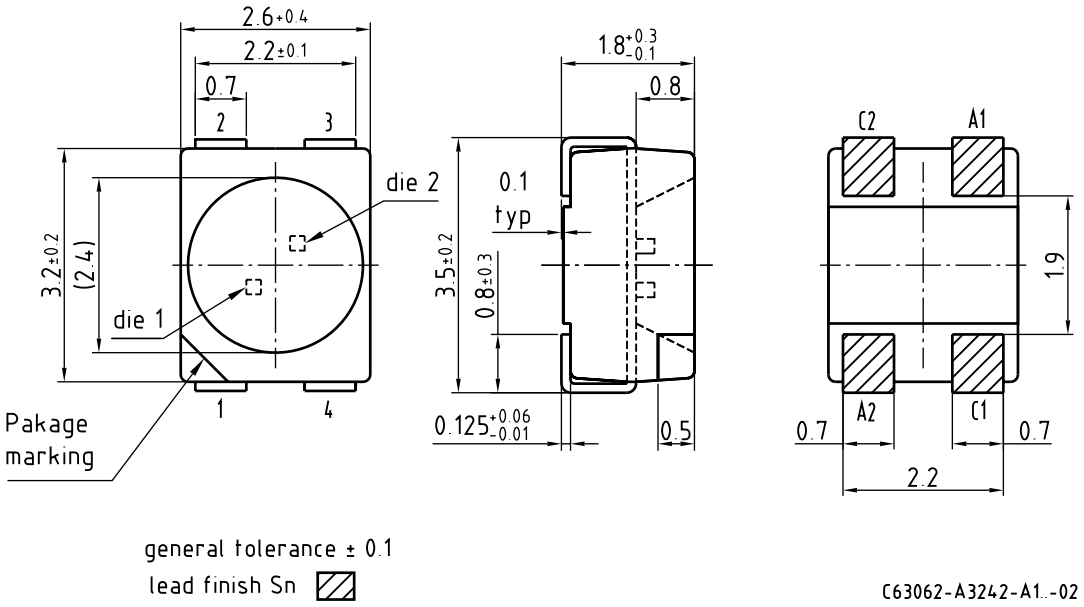
Permissible Pulse Handling Capability

IF = f(tp); D: Duty cycle; T_S = 85 °C



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Dimensional Drawing [9)]



Further Information:

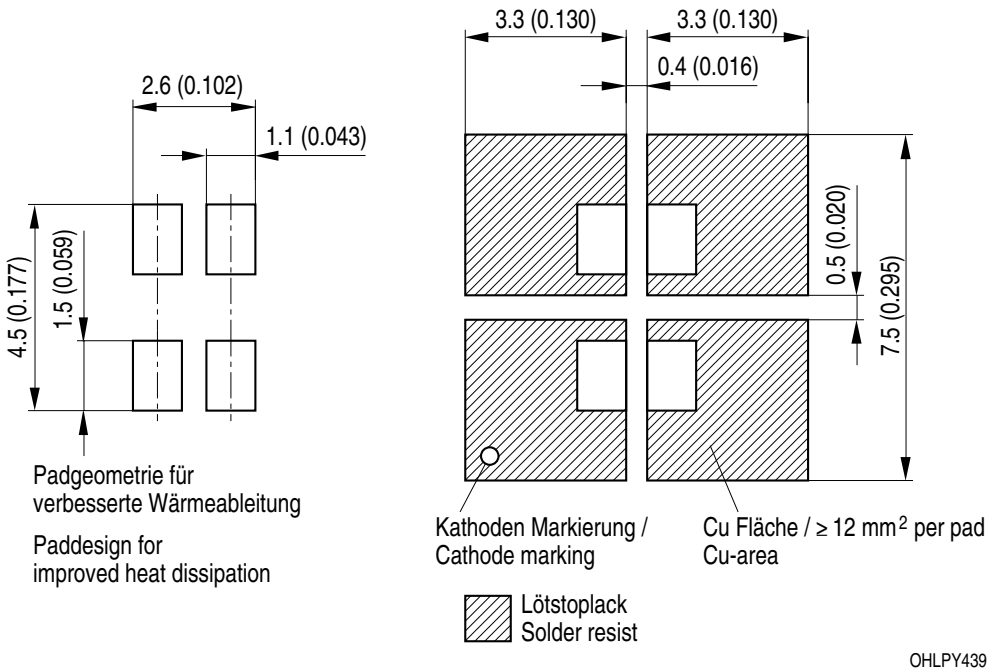
Approximate Weight: 35.0 mg

Corrosion test: Class: 3B
Test condition: 40°C / 90 % RH / 15 ppm H_2S / 14 days (stricter than IEC 60068-2-43)

Pin	Description
Pin 1	Cathode Yellow
Pin 2	Anode Yellow
Pin 3	Cathode Green
Pin 4	Anode Green

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Recommended Solder Pad [9)]

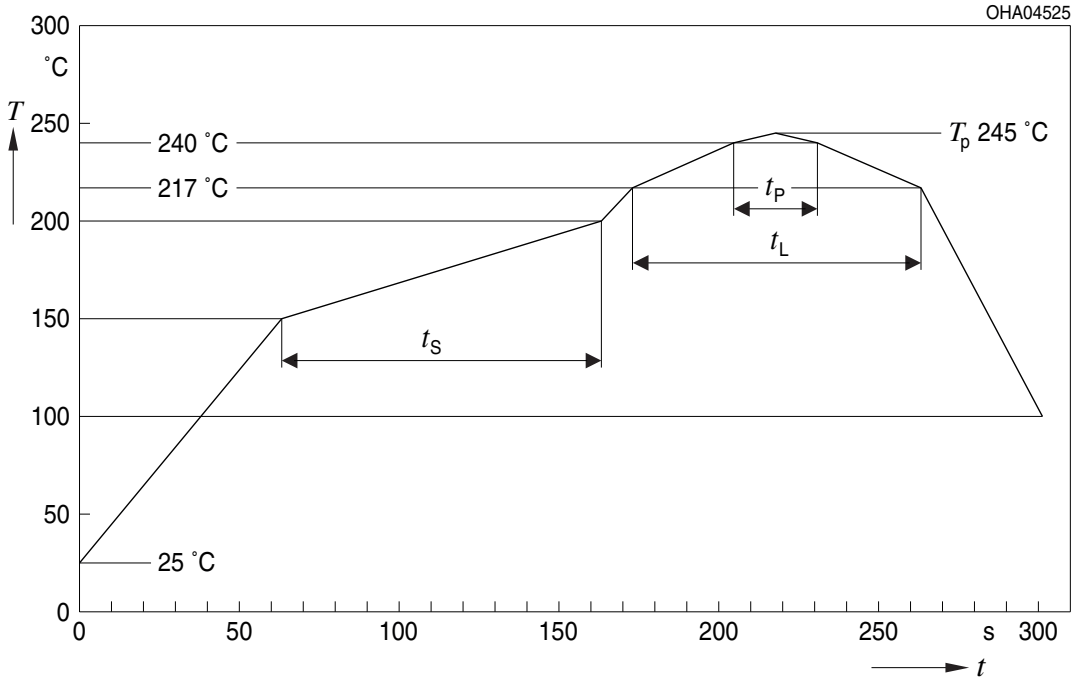


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.

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Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

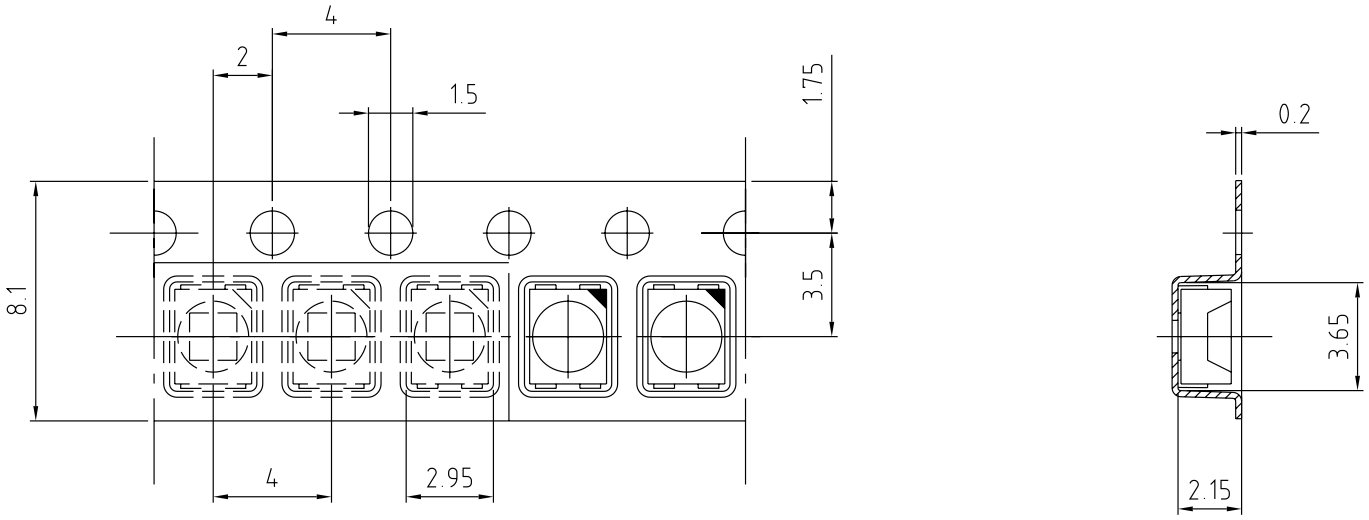


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time t_S T_{Smin} to T_{Smax}	t_S	60	100	120	s
Ramp-up rate to peak*) T_{Smax} to T_P			2	3	K/s
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	t_L		80	100	s
Peak temperature	T_P		245	260	°C
Time within 5 °C of the specified peak temperature T_P - 5 K	t_P	10	20	30	s
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time 25 °C to T_P				480	s

All temperatures refer to the center of the package, measured on the top of the component
* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

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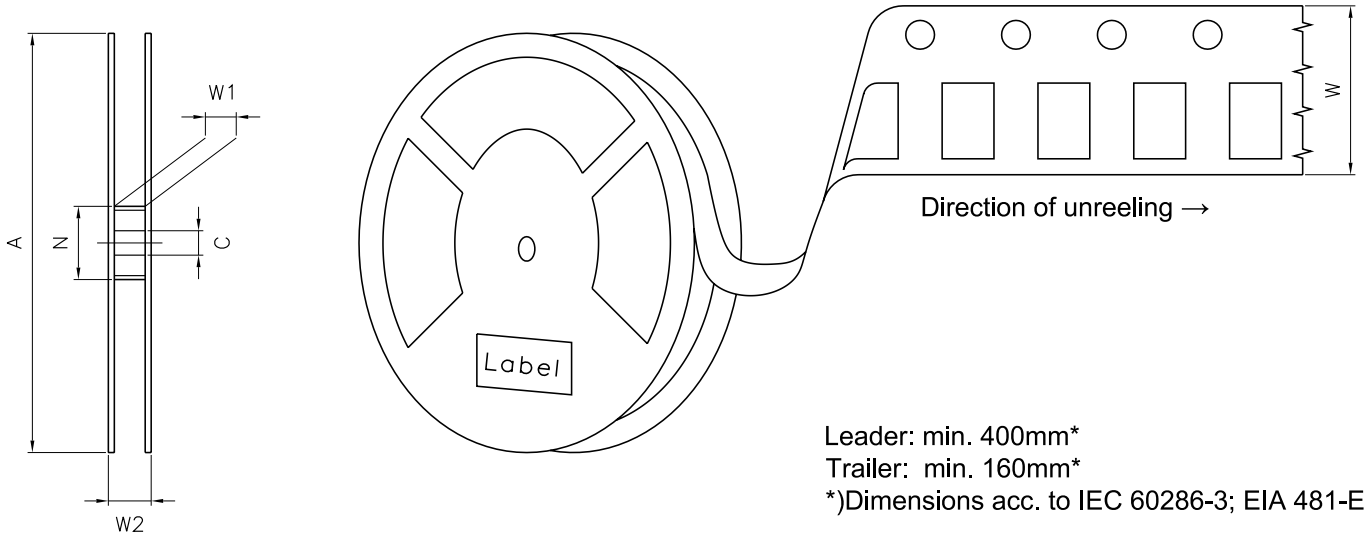
Taping [9)]



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Tape and Reel [10)]



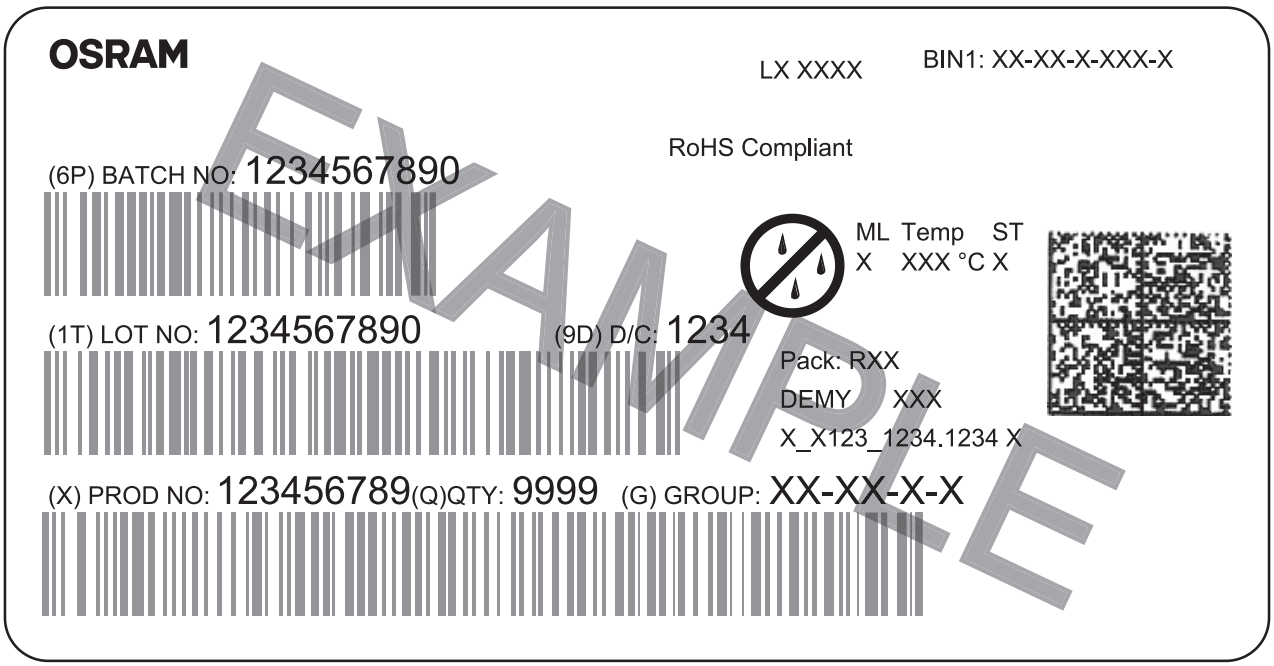
Leader: min. 400mm*
Trailer: min. 160mm*
*)Dimensions acc. to IEC 60286-3; EIA 481-E

Reel Dimensions

A	W	N_{min}	W_1	$W_{2\,max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	2000
330 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	8000

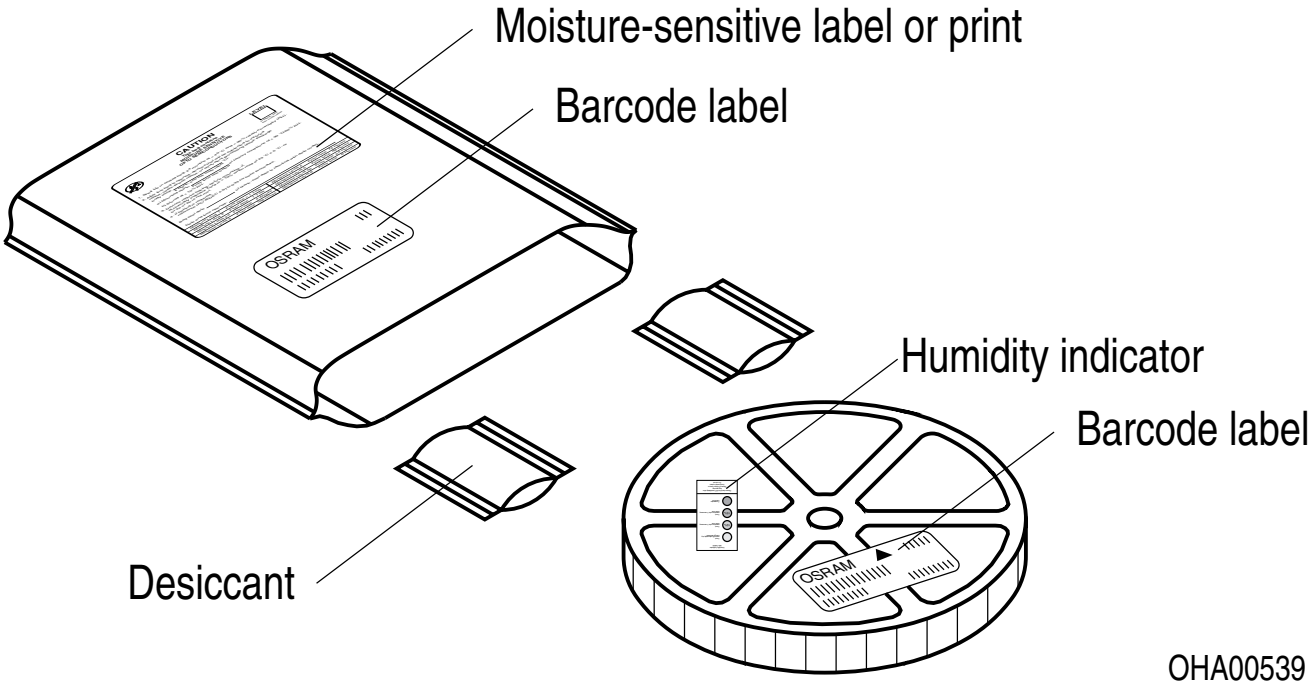
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Barcode-Product-Label (BPL)



OHA04563

Dry Packing Process and Materials [9)]

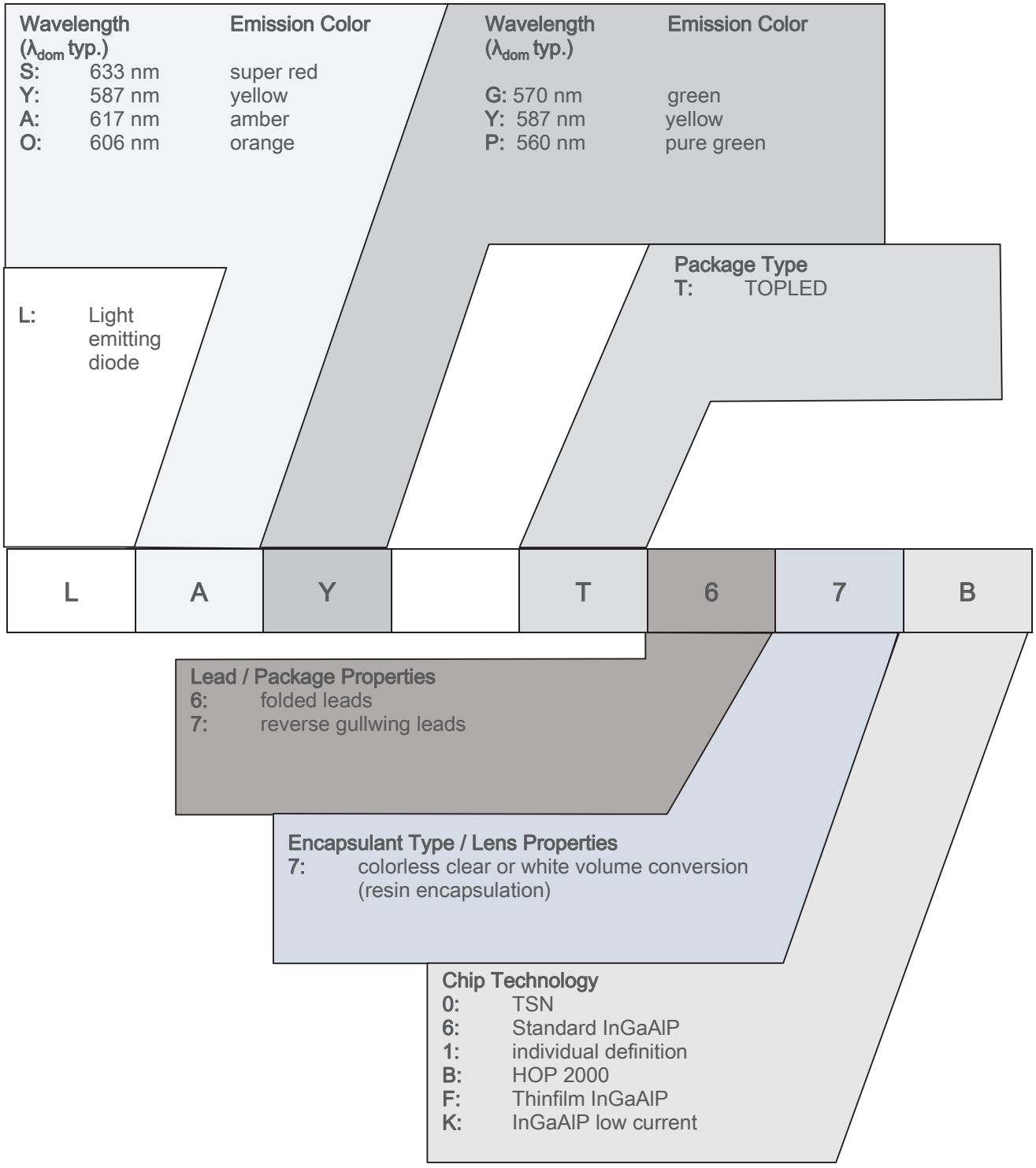


OHA00539

Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

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Type Designation System



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Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes

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Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics.
Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.
For information on the types in question please contact our Sales Organization.
If printed or downloaded, please find the latest version on our website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.
Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

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Glossary

1) **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).

2) **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.

3) **Wavelength:** The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).

4) **Forward Voltage:** Forward voltages are tested at a current pulse duration of 1 ms and a tolerance of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).

5) **Thermal Resistance:** Rth max is based on statistic values (6σ) used for Derating.

6) **Thermal Resistance:** RthJA results from mounting on PC board FR 4 (pad size 16 mm² per pad)

7) **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.

8) **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.

9) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.

10) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

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Revision History

Version	Date	Change
1.1	2022-07-01	New Layout Features Maximum Ratings Characteristics Brightness Groups Electro - Optical Characteristics (Diagrams) Derating (Diagrams) Applications
1.2	2024-11-21	Features

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